Specifications

Drawing No.	UKY1C-H1-24264-00[37] 1/11
Issued Date.	Mar.29,2024

TO: Digi-Key

Note: Part numbers may be revised in the event of any specifications change.

Product Name	Quartz Crystal
Product Model	CX2016DB
Frequency	48000kHz
Customer Part Number	-
Customer Specification Number	-
KYOCERA Part Number	CX2016DB48000C0FRLC1
Remarks	Pb-Free、RoHS Compliant、MSL 1 AEC-Q200 Compliant

Customer Acceptance

Accept Signature	Approved Date	
	Department	
	Person in charge	

Seller
KYOCERA Corporation
Corporate Electronic Components Group
Electronic Components Sales Division
6 Takeda Tobadono-cho, Fushimi-ku, Kyoto
612-8501 Japan
TEL. No. 075-604-3500
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Manufacturer

Corporate Electronic Components Group
Electronic Devices Division

Design Department	Quality Assurance	Approved by	Checked by	Issued by
KYOCERA Corporation Crystal Components Application Engineering Section 2 Electronic Devices Division Corporate Electronic Components Group	A. Ito	T. Nitobe	F. Horie	Y. Kikuchi

Revision History

Rev.No.	Description of revise	Date	Approved by	Checked by	Issued by
00	First Edition	Mar.29,2024	T. Nitobe	F. Horie	Y. Kikuchi

1. APPLICATION

This specification sheet is applied to quartz crystal “CX2016DB48000C0FRLC1”

2. KYOCERA PART NUMBER

CX2016DB48000C0FRLC1

3. RATINGS

Items	SYMB.	Rating	Unit	Remarks
Operating Temperature	Topr	-40 to +105	°C	
Storage Temperature range	Tstg	-40 to +125	°C	

4. CHARACTERISTICS

ELECTRICAL CHARACTERISTICS

Items	Electrical Specification					Test Condition	Remarks
	SYMB.	Min	Typ.	Max	Unit		
Mode of Vibration			Fundamental				
Nominal Frequency	F0		48		MHz		
Nominal Temperature	T_{NOM}		+25		°C		
Load Capacitance	CL		7.0		pF		
Frequency Tolerance	df/F	-10.0		+10.0	PPM	+25±3°C	by Measurement Conditions
Frequency Temperature Characteristics	df/F	-20.0		+20.0		-40 to +105°C	Based on an oscillation frequency at + 25 °C
Frequency Aging Rate		-1.0		+1.0		1st year	+25±3°C
Equivalent Series Resistance	ESR			30	Ω		by Measurement Conditions
Motional Capacitance	C1	-30%	2.9	+30%	fF		
Shunt Capacitance	C0	-30%	0.8	+30%	pF		
Motional Inductance	L1	-30%	3.8	+30%	mH		
Pull ability		-30%	-23.6	+30%	ppm/pF		
Drive Level	Pd	0.01		100	μW		
Insulation Resistance	IR	500			MΩ	100V(DC)	

5. Measurement Condition

5.1 Frequency measurement

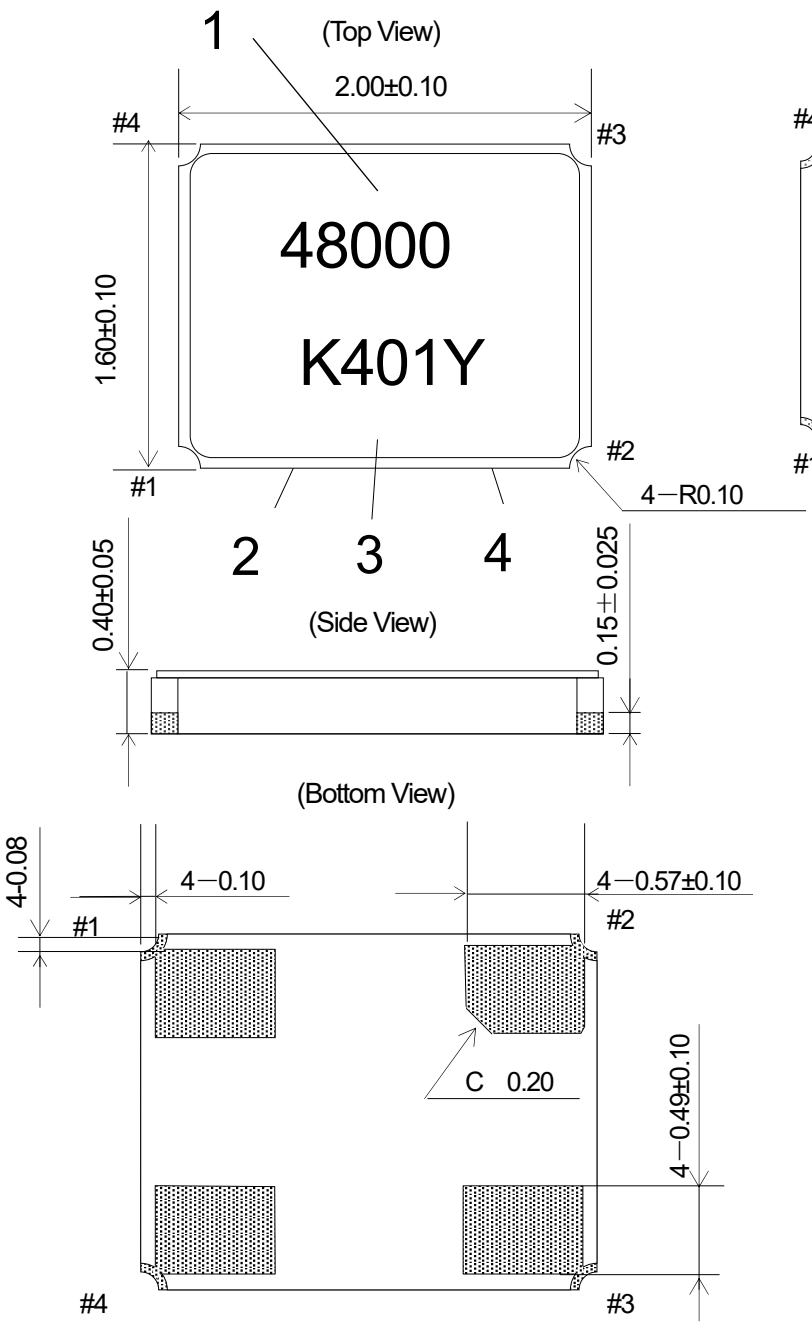
Measuring instrument	: IEC PI-Network Test Fixture
Load Capacitance	: 7.0pF
Drive Level	: 10μW

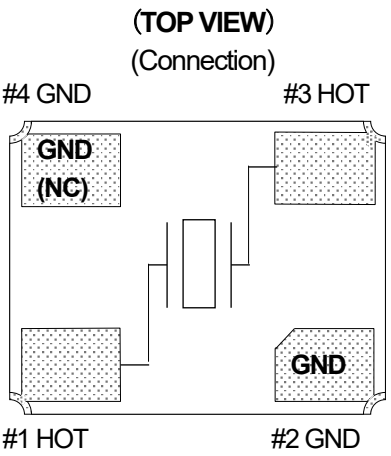
5.2 Equivalent series resistance (ESR) measurement

Measuring instrument	: IEC PI-Network Test Fixture
Load Capacitance	: Series
Drive Level	: 10μW

6. APPEARANCES, PHYSICAL DIMENSION

OUTLINE DIMENSION (not to scale)





PIN NO.	PIN Layout
#1	HOT
#2	GND
#3	HOT
#4	GND

UNIT : mm

MARKING

1 Nominal Frequency Move the number of maximum indication beams of the frequency to five digits, and omit less than kHz.

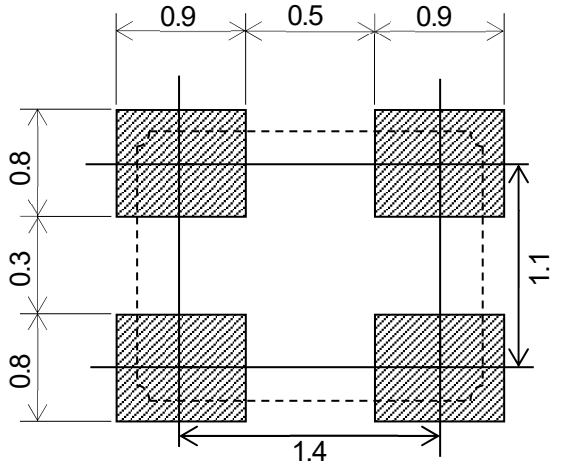
2 Identification [K] mark is surely 1Pin direction.

3 Date Code Year‥LAST 1 DIGIT of YEAR AND WEEK
(Ex)Jan,01, 2024 → 401

4 Manufacturing Location
Y‥Japan(Yamagata)
Z‥Japan(Shiga Yohkaichi)

※The font of marking is reference.

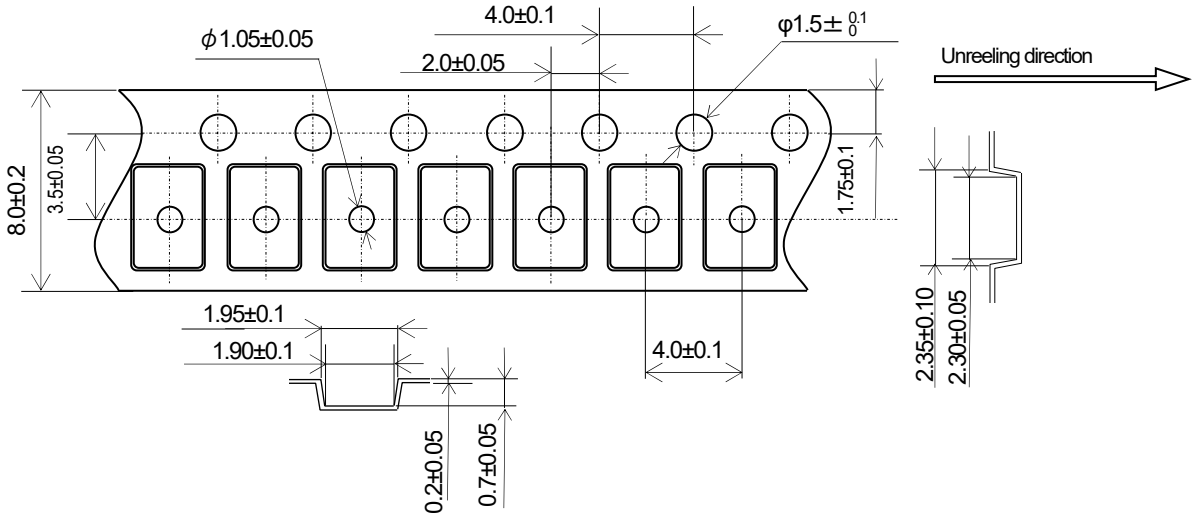
7. RECOMMENDED LAND PATTERN (not to scale)



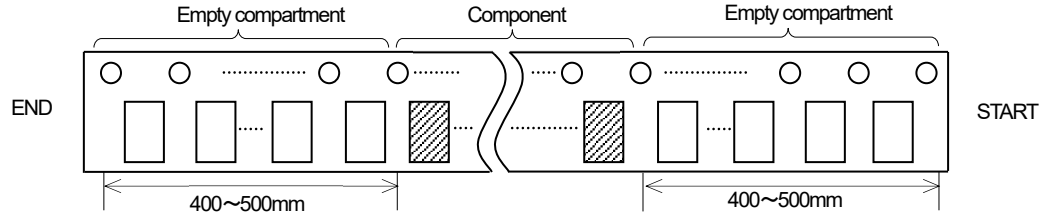
UNIT : mm

8. TAPING&REEL

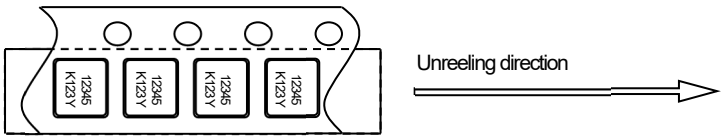
8-1.Dimensions



8-2.Leader and trailer tape

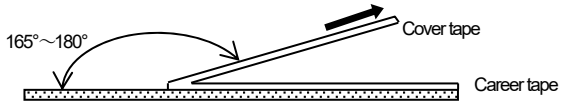


8-3.Direction（The direction shall be seen from the top cover tape side）

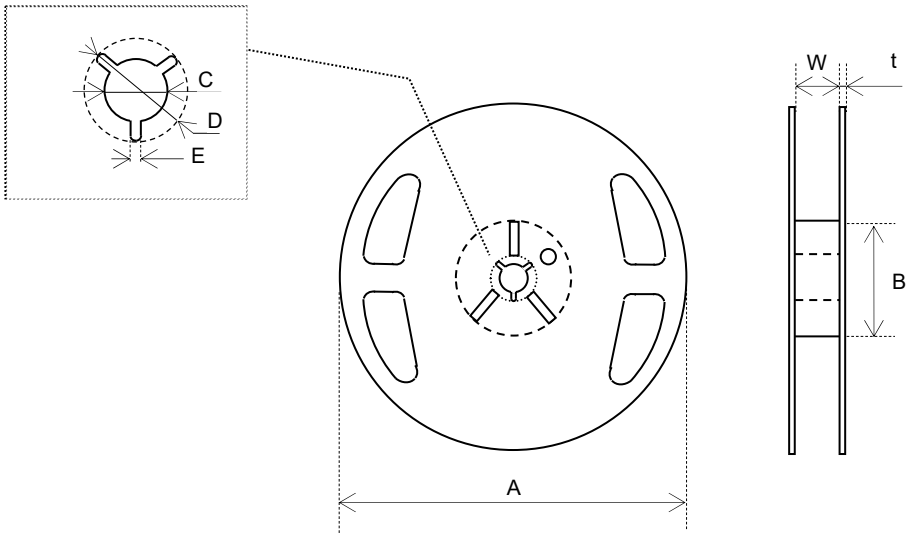


8-4.Specification

1. Material of the carrier tape is either polystyrene or A－PET (ESD).
2. Material of the cover tape is PET/PE (ESD).
3. The seal tape shall not cover the sprocket holes and not protrude from the carrier tape.
4. Tensile strength of carrier tape: 10N or more.
5. The R of the corner of each cavity is 0.2RMAX.
6. The alignment between centers of the cavity and sprocket hole shall be 0.05mm or less.
7. The orientation shall be checked from the top cover tape side as shown in 8-3.
8. Peeling force of cover tape: 0.1 to 1.0N.
9. The component will fall out naturally when cover tape is removed and set upside down.



8-5.Reel Specification



φ180 Reel (3,000pcs Max)

Symbol	A	B	C	D
Dimension	φ180 +0/-3	φ60 +1/-0	φ13±0.2	φ21±0.8
Symbol	E	W	t	
Dimension	2.0±0.5	9±1	2.0±0.5	

(Unit : mm)

φ330 Reel (15,000pcs Max)

Symbol	A	B	C	D
Dimension	φ330±2.0	φ100±1.0	φ13±0.2	φ21±0.8
Symbol	E	W	t	
Dimension	2.0±0.5	9.5±0.5	2.2±0.1	

(Unit : mm)

9. ENVIRONMENTAL AND MECHANICAL CHARACTERISTICS :

(Reference: AEC-Q200 Rev. D. The solder used by examination is hereafter set to Sn-3Ag-0.5Cu.)

After following test, frequency shall not change more than ±10×10^{-6} and CI, ±20% or 5Ω.

No	Stress	Reference	Additional Requirements
9.1	High Temperature Exposure (Storage)	MIL-STD-202 Method 108	1000 hrs. at rated operating temperature (e.g. 85°C part can be stored for 1000 hours at 85°C. Same applies for 125°C). Unpowered. Measurement at 24±4 hours after test conclusion.
9.2	Temperature Cycling	JESD22 Method JA-104	1000 cycles (-40°C to 125°C) Note: If 85°C parts the 1000 cycles will be at that temperature rating. Measurement at 24±4 hours after test conclusion. 30min maximum dwell time at each temperature extreme. 1 min. maximum transition time.
9.3	Biased Humidity	MIL-STD- 202 Method 103	1000 hours 85°C/85%RH. Rated VDD applied with 1MΩ and inverter in parallel, 2X crystal CL capacitors between each crystal leg and GND. Measurement at 24±4 hours after test conclusion.
9.4	Operational Life	MIL-STD- 202 Method 108	Note: 1000 hours @ 125°C. If 85°C part will be tested at that temperature. Rated VDD applied with 1 MΩ and inverter in parallel, 2X crystal CL capacitors between each crystal leg and GND. Measurement at 24±4 hours after test conclusion.
9.5	Resistance to Solvents	MIL-STD- 202 Method 215	Note: Also aqueous wash chemical - OKEM clean or equivalent. Do not use banned solvents.
9.6	Mechanical Shock	MIL-STD-202 Method 213	Figure 1 of Method 213. Condition C
9.7	Vibration	MIL-STD-202 Method 204	5g's for 20 minutes 12 cycles each of 3 orientations. Note: Use 8"X5" PCB .031" thick with 7 secure points on one 8" side and 2 secure points on corners of opposite sides. Parts mounted within 2" from any secure point. Test from 10-2000 Hz.
9.8	Resistance to Soldering Heat	MIL-STD-202 Method 210	Condition B. No pre-heat of samples. Solder temp: 260±5℃, Soaking time: 10±1sec, Number of tests: 1 Note: The electrodes are immersed in molten solder to a level that covers the electrodes of the component.
9.9	Solder ability	J-STD-002	Evaluate the solderability of external electrodes of components. Conditions (SMD): Method D category 3, Solder temp: 260±5°C, Soaking time: 30+5/-0sec.
9.10	Board Flex	AEC Q200-005	Maintain a bend depth of 2 mm for 60 seconds. Note: Use FR4 substrate with external dimensions of 100 x 40 mm and thickness of 1.6±02 mm.
9.11	Terminal Strength (SMD)	AEC Q200-006	A pushing force of 17.7 N perpendicular to the side of the specimen on the test substrate is applied for 60 seconds

10. Soldering condition

1.) Material of solder

Kind ⋯ lead free solder paste

Melting point ⋯ +220±5°C

2.) Reflow temp.profile

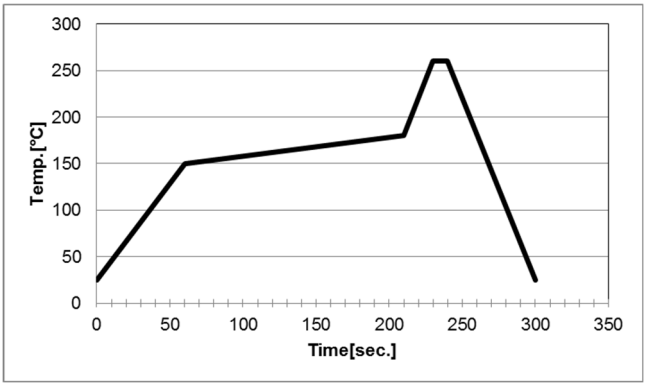
	Temp [°C]	Time[sec]
Preheating	+150 to +180	150 (typ.)
Peak	+260±5	10 (max.)
Total	—	300 (max.)

Frequency shift : ±2ppm

3.) Hand Soldering +350°C 3 sec MAX

4.) Reflow Times 2 times

Reflow temp.profile



11. Cautions for use

(1) Soldering upon mounting

There is a possibility to influence product characteristics when Solder paste or conductive glue comes in contact with product lid or surface.

(2) When using mounting machine

Please minimize the shock when using mounting machine to avoid any excess stress to the product.

(3) Conformity of a circuit

We strongly recommend to make sure that Negative resistance (Gain) of IC is designed to be 10 times the ESR (Equivalent Series Resistance) of crystal unit.

12. Storage conditions

Please store product in below conditions, and use within 6 months.

Temperature +18 to +30°C, and Humidity of 20 to 70 % in the packaging condition.

13. Manufacturing location

Kyocera Corporation Yamagata Higashine Plant / Japan(Yamagata)

Kyocera Corporation Shiga Yohkaichi Plant / Japan(Shiga)

14. Quality Assurance

To be guaranteed by Kyocera Corporation Yamagata Higashine Plant Quality Assurance Division

15. Quality guarantee

In case when Kyocera Corporation rooted failure occurred within 1year after its delivery, substitute product will be arranged based on discussion. Quality guarantee of product after 1year of its delivery is waivered.

16. Others

In case of any questions or opinions regarding the Specification, please have it in written manner within 45 days after issued date.

Unikeyic Electronics

Global Electronic Components Distributor

Click to view pricing, inventory, delivery, and lifecycle information:

AVX:

12061C473JAT2A TAJY107K016RNJ TPSB336K010R0500 SD1206S020S1R0 TPSC227K006R0100
1812HA101JAT2A SCCY68B407SSBLE TPME226K050R0075 04023C103KAT2A 0402YC103KAT4A
08053D106KAT4A 08055C682KAT2A 600S1R0AT250XT4K NOJA226M006RWJ TCJB476M010R0070
04025A101KAT2A 609176001415000 DT2012SB32768H5HPWAA TCJB476M010R0070E FE52GI8I0227KB
TCJB106M035R0200 TCJA336M006R0200E 06033C104KAT2A 600S3R3AW250XT GG0402126R042P
TAJB476K006RNJ TAJC337K006RNJ VC120618D400DP 04025C821KAT2A 08055A471JAT2A